imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



SiZ346DT

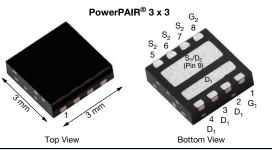
RoHS COMPLIANT

HALOGEN

FREE

www.vishay.com

Dual N-Channel 30 V (D-S) MOSFETs



PRODUCT SUMMARY

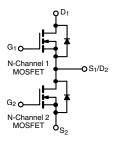
	CHANNEL-1	CHANNEL-2	
V _{DS} (V)	30	30	
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0285	0.0115	
$R_{DS(on)}$ max. (Ω) at V_GS = 4.5 V	0.0370	0.0153	
Q _g typ. (nC)	3.2	4.5	
I _D (A) ^g	17	30 ^a	
Configuration	Dual		

FEATURES

- TrenchFET[®] Gen IV power MOSFETs
- 100 % R_g and UIS tested
- Optimized Q_{as}/Q_{as} ratio improves switching characteristics
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- CPU core power
- Computer / server peripherals
- POL
- Synchronous buck converter
- Telecom DC/DC



ORDERING INFORMATION	
Package	PowerPAIR 3 x 3
Lead (Pb)-free and halogen-free	SiZ346DT-T1-GE3

ABSOLUTE MAXIMUM RATINGS (TA	= 25 °C, unless	s otherwise n	oted)		
PARAMETER		SYMBOL	CHANNEL-1	CHANNEL-2	UNIT
Drain-source voltage		V _{DS}	30	30	V
Gate-source voltage		V _{GS}	± 20	+20, -16	v
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		17	30	
	T _C = 70 °C		13.8	24	
	T _A = 25 °C	I _D	8 b, c	14.1 ^{b, c}	
	T _A = 70 °C		6.3 ^{b, c}	11.3 ^{b, c}	٨
Pulsed drain current (100 µs pulse width)	I _{DM}	25	100	A	
Continuous source drain diode current	T _C = 25 °C	- I _S	13.4	13.9	
	T _A = 25 °C		2.8 ^{b, c}	3.1 ^{b, c}	
Single pulse avalanche current	100 mll	I _{AS}	9	10	
Single pulse avalanche energy	L = 100 mH	E _{AS}	4.1	5	mJ
	T _C = 25 °C		16	16.7	
Maximum power dissipation	T _C = 70 °C	P _D	10.3	10.7	14/
	T _A = 25 °C		3.4 ^{b, c}	3.7 ^{b, c}	W
	T _A = 70 °C	1	2.2 ^{b, c}	2.4 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		°C
Soldering recommendations (peak temperature) d			260		-0

THERMAL RESISTANCE RATINGS								
PARAMETER		SYMBOL	CHANNEL-1		CHANNEL-2		UNIT	
			TYP.	MAX.	TYP.	MAX.		
Maximum junction-to-ambient ^{b, f}	t ≤ 10 s	R _{thJA}	30	37	27	34	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	6.3	7.8	6	7.5	- C/W	

Notes a. Package limited b. Surface mounted on 1" x 1" FR4 board

Ċ.

t = 10 sSee solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAIR is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 71 °C/W for channel-1 and 69 °C/W for channel-2 $T_c = 25 \text{ °C}$ d.

e f.

g.

S17-0249-Rev. A, 20-Feb-17

1

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

www.vishay.com

VISHAY

SiZ346DT Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							1
		$V_{GS} = 0 V, I_D = 250 \mu A$	Ch-1	30	-	-	
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	Ch-2	30	-	-	V
		$I_D = 250 \mu\text{A}$	Ch-1	-	31	-	-
V _{DS} Temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA	Ch-2	-	20	_	
		I _D = 250 μA	Ch-1	-	-4.9	-	mV/°C
V _{GS(th)} Temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	Ch-2	-	-5.6	-	1
		V _{DS} = V _{GS} , I _D = 250 μA	Ch-1	1.1	-	2.2	.,
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	Ch-2	1.2	-	2.4	V
	1	$V_{DS} = 0 V, V_{GS} = +20 V, -20 V$	Ch-1	-	-	± 100	
Gate source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = +20 V, -16 V$	Ch-2	-	-	± 100	nA
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-1	-	-	1	
Zaus ante coltana dusia sumant		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-2	-	-	1	μA
Zero gate voltage drain current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	Ch-1	-	-	5	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	Ch-2	-	-	5	1
On state drain surrent b		$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	Ch-1	10	-	-	A
On-state drain current ^b	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	Ch-2	10	-	-	
Drain-source on-state resistance ^b		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	Ch-1	-	0.0230	0.0285	
	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 14.4 \text{ A}$	Ch-2	-	0.0084	0.0115	370 ^Ω
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	Ch-1	-	0.0300	0.0370	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 13 \text{ A}$	Ch-2	-	0.0111	0.0153	
Forward transconductance b	Q .	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	Ch-1 - 17	-	s		
Forward transconductance ~	9 _{fs}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 14.4 \text{ A}$	Ch-2	-	17	-	3
Dynamic ^a							
Input capacitance	C		Ch-1	I	325	-	
input capacitance	C _{iss}		Ch-2	I	650	-	
Output capacitance	C _{oss}	Channel-1	Ch-1	-	66	-	pF
Output capacitance	O _{oss}	$V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz$	Ch-2	-	236	-	рі
Reverse transfer capacitance	C _{rss}	Channel-2	Ch-1	-	33	-	
neverse transfer capacitance	Orss	V_{DS} = 15 V, V_{GS} = 0 V, f = 1 MHz	Ch-2	-	20	-	
C _{rss} /C _{iss} ratio			Ch-1	-	0.1	0.2	
Orss/ Olss Tallo			Ch-2	-	0.03	0.06	
Total gate charge	Qg	V_{DS} = 15 V, V_{GS} = 10 V, I_D = 5 A	Ch-1	-	6.6	10	
		V_{DS} = 15 V, V_{GS} = 10 V, I_{D} = 14.4 A	Ch-2	I	10	20	
	Qg	V_{DS} = 15 V, V_{GS} = 4.5 V, I_D = 5 A	Ch-1	-	3.2	5	
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 14.4 \text{ A}$	Ch-2	-	4.5	9	
Gate-source charge	0	Channel-1	Ch-1	-	1	-	nC
	√gs	Q_{gs} $V_{DS} = 15 V, V_{GS} = 4.5 V, I_D = 5 A$	Ch-2	-	2.1	-	
	0.	Channel-2	Ch-1	-	1.2	-	
	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 14.4 \text{ A}$	Ch-2	-	0.7	-	_	
Output charge	Q _{oss}	V _{DS} = 15 V, V _{GS} = 0 V	Ch-1	-	1.5	-	
	QOSS	v_{DSS} $v_{\text{DS}} = 15 \text{ V}, v_{\text{GS}} = 0 \text{ V}$		-	6.6	-	
Gate resistance	R _g	f=1 MHz	Ch-1	0.2	0.85	1.7	0
Gate resistance			Ch-2	0.3	1.4	2.8	Ω

Document Number: 68128

www.vishay.com

SiZ346DT

Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Dynamic ^a							
Turn-on delay time	+		Ch-1	-	7	15	
Tum-on delay time	t _{d(on)}	Channel-1	Ch-2	-	8	16	
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 3 \Omega$	Ch-1	-	40	80	
	۲	$I_D \cong 5 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, R_g = 1 \Omega$	Ch-2	-	15	30	
Turn-off delay time	t _{d(off)}	Channel-2	Ch-1	-	7	15	
	4 (01)	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 1.5 \Omega$	Ch-2	-	17	35	
Fall time	t _f	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{ R}_g = 1 \Omega$	Ch-1	-	8	20	
	-1		Ch-2	-	7	15	ns
Turn-on delay time	t _{d(on)}		Ch-1	-	14	30	
	۹(on)	Channel-1	Ch-2	-	15	30	-
Rise time	tr	$V_{DD} = 10 \text{ V}, \text{ R}_{L} = 2 \Omega$	Ch-1	-	53	100	
	۲	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega$	Ch-2	-	50	100	
Turn-off delay time Fall time	t _{d(off)} t _f	Channel-2 $V_{DD} = 15 V, R_{L} = 1.5 \Omega$	Ch-1	-	10	20	
			Ch-2	-	16	30	
		$I_D \cong 10$ Å, $V_{GEN} = 4.5$ V, $R_g = 1 \Omega$		-	30	60	
	ч		Ch-2	-	10	20	
Drain-Source Body Diode Characteri	stics						•
Continuous source-drain diode current	Is	T _C = 25 °C	Ch-1	-	-	13.4	
	'5	10 - 20 0	Ch-2	-	-	13.9	A
Pulse diode forward current (t = $100 \ \mu s$)	I _{SM}		Ch-1	-	-	25	
	12101		Ch-2	-	-	100	
Body diode voltage	V _{SD}	$I_{\rm S} = 5$ A, $V_{\rm GS} = 0$ V	Ch-1	-	0.87	1.2	v
Loay aload voltage	* SD	$I_{\rm S}$ = 10 A, $V_{\rm GS}$ = 0 V	Ch-2	-	0.8	1.2	
Body diode reverse recovery time	e t _{rr}		Ch-1	-	20	40	ns
			Ch-2	-	20	40	
Body diode reverse recovery charge	Q _{rr}	Channel-1 I _F = 5 A, dl/dt = 100 A/µs, T _J = 25 °C	Ch-1	-	15	30	nC
			Ch-2	-	10	20	
Reverse recovery fall time	t _a	Channel-2	Ch-1	-	13	-	
		I _F = 10 A, dl/dt = 100 A/μs, T _J = 25 °C	Ch-2	-	12.5	-	ns
Reverse recovery rise time	t _b		Ch-1	-	7	-	115
			Ch-2	-	7.5	-	

Notes

a. Guaranteed by design, not subject to production testing

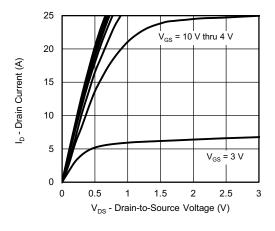
b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

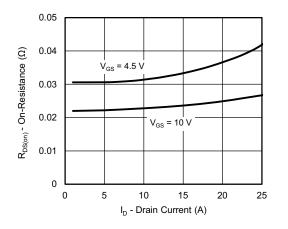
3



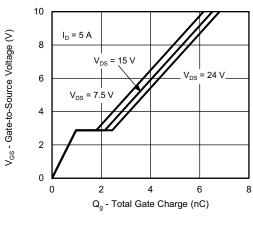
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



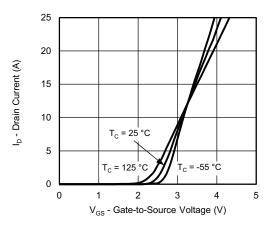
Output Characteristics



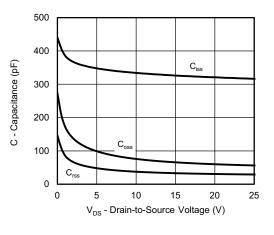
On-Resistance vs. Drain Current



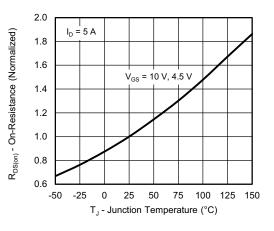
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

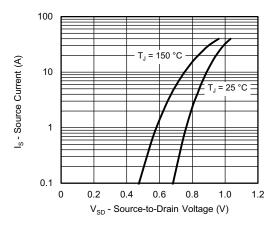
S17-0249-Rev. A, 20-Feb-17

4 questions contact: pmostechsupport Document Number: 68128

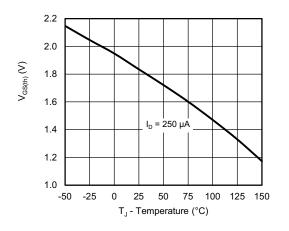
For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



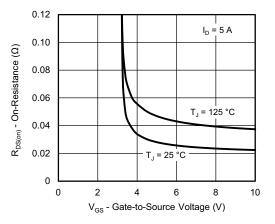
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



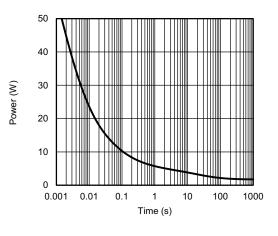
Source-Drain Diode Forward Voltage



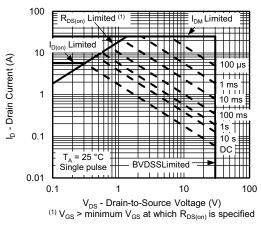
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

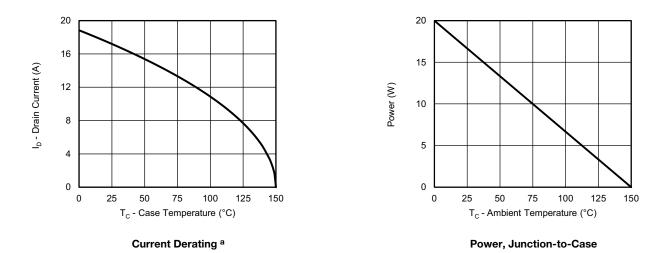
S17-0249-Rev. A, 20-Feb-17

5

For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

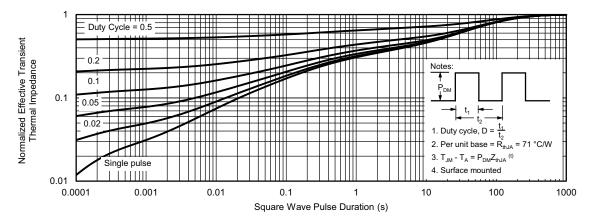


Note

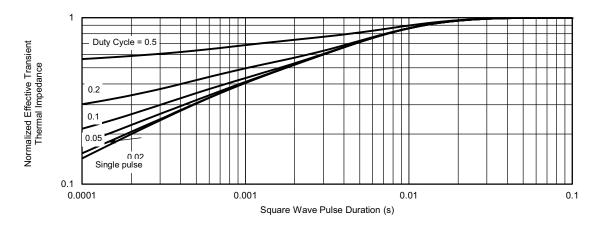
a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

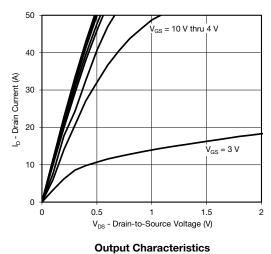


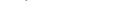
Normalized Thermal Transient Impedance, Junction-to-Case

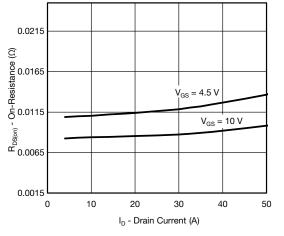
7



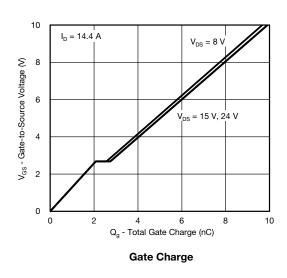
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

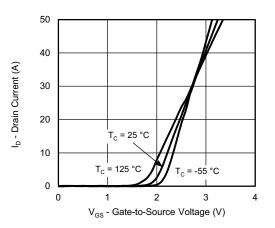




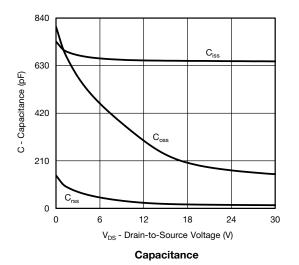


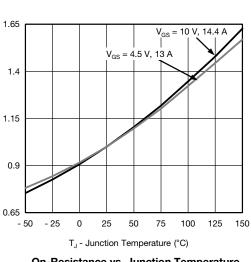
On-Resistance vs. Drain Current





Transfer Characteristics





On-Resistance vs. Junction Temperature

S17-0249-Rev. A, 20-Feb-17

8

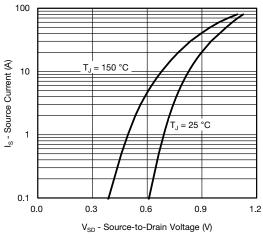
R_{DS(on)} - On-Resistance (Normalized)

Document Number: 68128

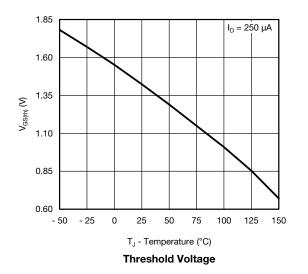
For technical questions, contact: pmostechsupport@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

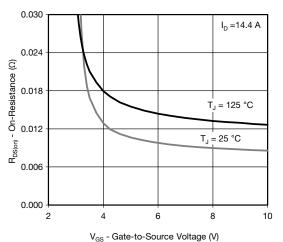


CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

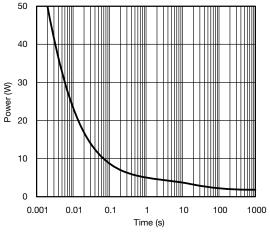


Source-Drain Diode Forward Voltage

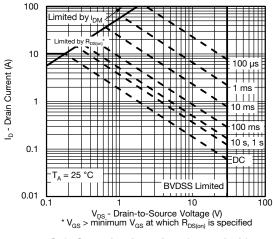




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

9

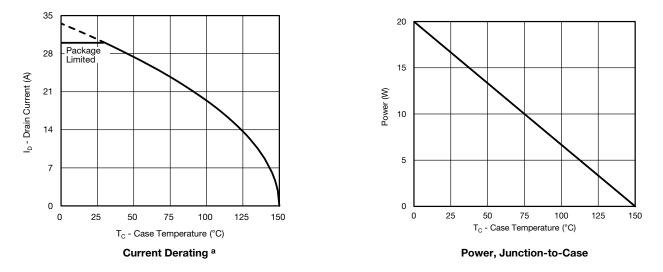
For technical questions, contact: <u>pmostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



SiZ346DT

Vishay Siliconix

CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

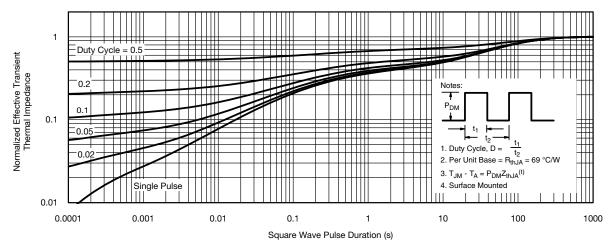


Note

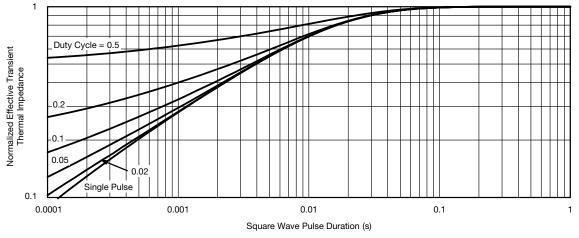
a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?68128.



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.